

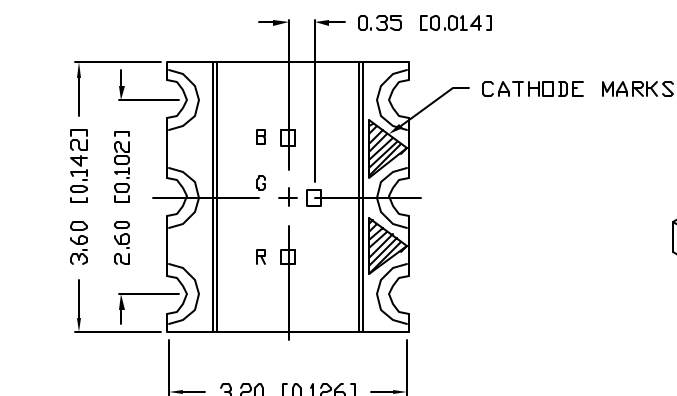
UNCONTROLLED DOCUMENT

PART NUMBER

SML-LX3632SISUGSBC

REV.

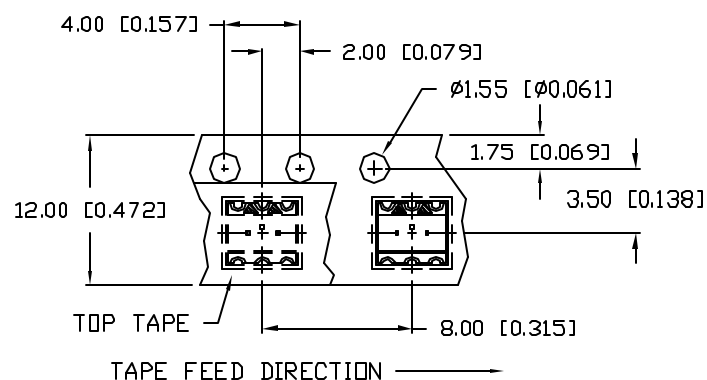
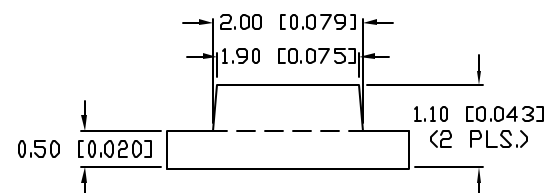
C



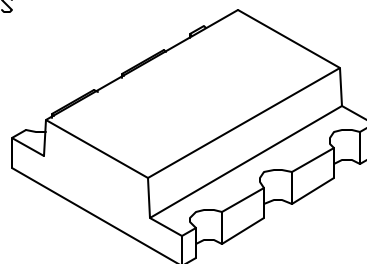
BLUE

GREEN

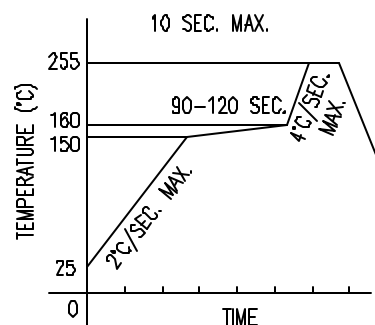
RED



*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X=±1 (±0.038), XX=±0.5 (±0.020), XXX=±0.25 (±0.010), XXXX=±0.127 (±0.005). LEAD SIZE=±0.05 (0.002), LEAD LENGTH=±0.75 (±0.030). MIN=+DECIMAL PRECISION MAX=+0.00 -DECIMAL PRECISION

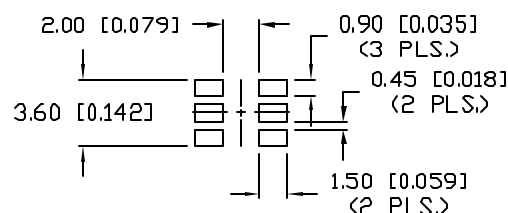


LEAD FREE REFLOW PROFILE



TOTAL TIME ABOVE 220°C IS 60 SECONDS MAX.

RECOMMENDED SOLDER PAD LAYOUT



ELECTRO-OPTICAL CHARACTERISTICS T _A =25°C I _f =20mA					
PARAMETER	RED	GREEN	BLUE	UNITS	TEST COND
PEAK WAVELENGTH	636	574	430	nm	
FORWARD VOLTAGE (TYP.)	2.0	2.2	3.5	V _f	
FORWARD VOLTAGE (MAX.)	2.4	2.6	4.5	V _f	
REVERSE VOLTAGE	5.0	5.0	5.0	V _r	I _r =100μA
AXIAL INTENSITY	75	60	50	mcd	I _f =20mA
VIEWING ANGLE	120	120	120	2x theta	
LED POSITION:	1	2	3		
EPOXY LENS FINISH: WATER CLEAR					

LIMITS OF SAFE OPERATION AT 25°C PER CHIP

PARAMETER	COLORS	MAX	UNITS
PEAK FORWARD CURRENT*	(R/G/B)	160/160/70	mA
STEADY CURRENT	(R/G/B)	25/25/30	mA
POWER DISSIPATION		60/60/140	mW
DERATE FROM 25°C	(R/G/B)	-1.2/-1.2/-1.6	mW/°C
OPERATING, STORAGE TEMP.		-40 TO +85	°C
SOLDERING TEMP.		+260	°C
2.0mm FROM BODY		3 SEC. MAX	

* t<10μS

NOTES:

1. THE CATHODE IS ORIENTED TOWARDS THE SPROCKET HOLE.

CAUTION: STATIC SENSITIVE DEVICE
FOLLOW PROPER E.S.D. HANDLING PROCEDURES
WHEN WORKING WITH THIS PART.

CAUTION: MOISTURE SENSITIVE DEVICE
PER JEDEC LEVEL 4 STANDARDS



UNCONTROLLED DOCUMENT

REV.

C

PART NUMBER

SML-LX3632SISUGSBC

3.2 x 3.6mm SURFACE MOUNT LED, TRI COLOR,
SUPER INTENSITY RED, SUPER ULTRA GREEN, SUPER BLUE,
WATER CLEAR LENS, TAPE AND REEL

CONFIDENTIAL INFORMATION

THE INFORMATION CONTAINED IN THIS DOCUMENT IS THE PROPERTY OF LUMEX INC. EXCEPT AS SPECIFICALLY AUTHORIZED IN WRITING BY LUMEX INC., THE HOLDER OF THIS DOCUMENT SHALL KEEP ALL INFORMATION CONTAINED HEREIN CONFIDENTIAL AND SHALL PROTECT SAME IN WHOLE OR IN PART FROM DISCLOSURE AND DISSEMINATION TO ALL THIRD PARTIES.

RELIABILITY NOTE

OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.



290 E. HELEN ROAD
PALATINE, IL 60067-6976
PHONE: +1.847.359.2790
US WEB: www.lumex.com
TW WEB: www.lumex.com.tw

DRAWN BY:

GB

CHECKED BY:

APPROVED BY:

DATE: 6.4.02

PAGE: 1 OF 1

SCALE: N/A